

TECHNICAL DATASHEET GTEC Thermal XP Board

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Description

GTEC Thermal XP Board is for use as a superior drylining board laminate with enhanced thermal insulation.

Appearance

GTEC Thermal XP Board is coloured ivory on the front and has orange polystyrene extruded board foam on the back and has tapers down the long edges of the front.

Composition

Aerated Calcium sulphate di-hydrate enclosed inside liners made from recycled waste paper with bound edges. Core and papers are bonded with starch. Edge glue is PVA. Various thicknesses of Extruded polystyrene (XPS) are factory bonded to 9.5 mm board using PVA adhesive.

Compliance

GTEC Standard Board complies with BS EN 520:2004+A1:2009 Type A and the laminate complies with the European standard BS EN 13950: 2014 The XPS Insulation complies with BS EN 13164

Physical Properties

Flexural Strength to BS EN 520: 9.5 mm board Longitudinal breaking load ≥ 400 N Transverse breaking load ≥ 160 N

Water vapour resistance

27 mm = 9.07 MNs/g 35 mm = 13.07 MNs/g 55 mm = 23.07 MNs/g

Fire, acoustic, thermal & duty performance dependent on the whole system. See Siniat Drywall Manual for Siniat system performances.

Reaction to fire: Euroclass B-s1, d0

Moisture Content: < 2 %

Mass: 27 mm = 6.5 kg/m² 35 mm = 6.8 kg/m² 55 mm = 7.4 kg/m² The density of the XPS is 30 kg/m³ Laminate weight:

18.7 kg for 2400 mm x 1200 mm x 27 mm board 19.6 kg for 2400 mm x 1200 mm x 35 mm board 21.3 kg for 2400 mm x 1200 mm x 55 mm board

Thermal Conductivity, λ_R : XP Insulation: 0.033 W/mK Plasterboard: 0.19 W/mK

Thermal resistance, R:

The thermal resistance is significantly superior compared with EPS laminates 27 mm = 0.58 m²K/W 35 mm = 0.81 m²K/W 55 mm = 1.41 m²K/W

Environment & Sustainability

Global Warming Potential (GWP) < 5 Ozone Depleting Potential (ODP) = 0

Fixing

Use either dabs of GTEC Universal Bonding compound (two additional nailable plugs required for fire safety), GTEC Wall Lining Adhesive, GTEC Shallow Wall Channels (MFCS) or the GTEC Dryliner system.

Jointing Finishing & Painting

GTEC Thermal XP Board should be jointed and finished with GTEC Jointing Systems. Boards are suitable for gypsum finishing plasters manufactured to BS EN 13279-1:2008. The boards require priming with GTEC Universal Sealer prior to decorating.

GTEC Vapour Board option

GTEC Thermal XP Board is available with a vapour control layer of metallised polyester film within the laminate which enhances the vapour resistance of the product.

Health & Safety

Please refer to the Laminates Health and Safety Datasheet available on our website.

Individual board weight values may occasionally exceed nominal weights published in this datasheet.

Consult local building regulations for use in external walls in buildings over 18 m.

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Please check that this is the current version by visiting the Siniat website. For archived versions please contact technical services.

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